

## CALENDAR

### Upcoming: August 26–31, Scientific Basis for Nuclear Waste Management Symposium, MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.

**MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.**

▼ identifies a new or revised entry this month.

See the May 2000 MRS BULLETIN for July 2000 Calendar entries.

#### AUGUST 2000

**1–4** ▼ Intl. Conf. on Superplasticity and Advanced Materials, *Orlando, FL*. N. Chandra, Dept. of Mechanical Engineering, FAMU-FSU College of Engineering, 2525 Pottsdamer St., Tallahassee, FL 32310; 850-410-6320; fax 850-410-6420; e-mail chandra@eng.fsu.edu.

**3–4** ▼ Conf. on Advances in Applying Integrated Commercial-off-the-Shelf Microelectromechanical Systems, *Berkeley, CA*. The Knowledge Foundation, 18 Webster St., Brookline, MA 02446; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

**6–11** 7th International Symposium on Polymer Electrolytes (ISPE7), *Noosa, Queensland, Australia*. Astrid Nordmann, ISPE7 Conference Secretariat, Centre for Advanced Materials Technology, Monash University, Wellington Road, Clayton, Victoria, 3168, Australia; 61-3-9905-5791; fax 61-3-9904-4998; e-mail ispe7@eng.monash.edu.au; http://www.chem.monash.edu.au/electrolytes/ispe7/.

**6–11** 16th IUPAC Conf. on Chemical Thermodynamics, concurrent with 55th Calorimetry Conf. and 10th Symposium on Thermodynamics of Nuclear Materials, *Halifax, Nova Scotia, Canada*. M.A. White, Dept. of Chemistry, Dalhousie Univ., Halifax, Nova Scotia B3H 4J3, Canada; phone and fax 902-494-3894; e-mail icct@is.dal.ca; http://is.dal.ca/~ICCT.

**6–11** Intl. Conf. on Magnetism, *Recife, Brazil*. S. Rezende; 55-81-281-8450; fax 55-81-271-0359; e-mail smr@df.ufpe.br.

**7–10** 8th Asia Pacific Physics Conf., *Taipei, Taiwan*. O. Huang, Conf. Secretariat, c/o Inst. of Physics, Academia Sinica, Nankang 115, Taipei, Taiwan; 886-2-27899602; fax 886-2-27829636; e-mail appc2k@phys.sinica.edu.tw.

**9–12** Meeting of the APS Division of Particles and Fields, *Columbus, OH*. S. Raby; 614-292-3910; e-mail raby@mps.ohio-state.edu; www.dpf2000.org.

**13–16** Nonlinear Optics Topical Meeting, *Mauli, HI*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**13–17** ▼ Joint Meeting of the American Statistical Assoc., Inst. of Mathematical Statistics, Statistical Society of Canada Intl., and Biometric Society Eastern and Western North America Regions, *Indianapolis, IN*. American Statistical Assoc., 1429 Duke St., Alexandria, VA 22314-3415; www.amstat.org/meetings/jsm/2000.

**13–18** 12th American Conf. on Crystal Growth and Epitaxy, *Vail, CO*. T. Gentile, ACCGE-12 Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; fax 805-492-4062; e-mail aacg@lafn.org; www.aml.arizona.edu/aacg.

**15–19** Conf. on Nuclear Structure, *East Lansing, MI*. S. Conroy; 517-333-6333; e-mail NS2000@nslc.msu.edu; www.nslc.msu.edu/conferences/NS2000.

**16–18** 4th Latin American Colloquium on Fracture and Fatigue, *Neuquén, Argentina*. Grupo Mecánica de Fractura Facultad de Ingeniería, Univ. Nacional del Comahue, Buenos Aires 1400, (8300) Neuquén, Argentina; 54-299-4490355; e-mail sam@uncoma.edu.ar; www.uncoma.edu.ar/actividades/sam2000.

**16–20** 12th Intl Conf. on Textures of Materials, *Montreal, Canada*. N. Procyshyn, Dept. of Mining and Metallurgical Engineering, McGill Univ., 3450 University St., Montreal, Quebec, H3A 2A7, Canada; 514-398-4383; fax 514-398-7099; e-mail norma@minmet.lan.mcgill.ca; http://www.icotom12.ica.ca.

**16–22** Jahn Teller Symposium, *Boston, MA*. M. Kaplan, Simmons College and Boston Univ.; 617-521-2727; e-mail kaplan@buphy.bu.edu.

**20–23** 39th Annual Conf. of Metallurgists, *Ottawa, Canada*. H. Mostaghaci, Advanced Materials Group, Industry Canada, 235 Queen St., Ottawa, ON K1A 0H5, Canada; 613-954-5012; fax 613-952-4209; e-mail mostaghaci.hamid@ic.gc.ca.

**20–25** 5th Intl. Conf. on Nanostructured Materials, *Sendai, Japan*. Conf. Secretariat, Nano2000, Inst. for Materials Research, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 98577, Japan; 81-22-215-2256; fax 81-22-215-2111; e-mail nano2000@imr.tohoku.ac.jp; http://koho.imr.tohoku.ac.jp/nano-2000/.

**20–25** 17th Intl Conf. on Raman Spectroscopy, *Beijing, China*. H. Zhou, Secretary General, Dept. of Physics, Peking Univ., Beijing 100871, China; 8610-6275-1750; fax 8610-6275-9117; e-mail icors@pku.edu.cn; http://www.hkics.com/icors2000 or http://www.pku.edu.cn/others/icors/icors.htm.

**20–25** ▼ ACS Symposium on Materials for Transportation, *Washington, DC*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**21–23** ▼ Conf. on Photon Correlation and Scattering, *Whistler, British Columbia, Canada*. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg-conf/.

**21–25** 13th Intl. Symposium on Exoemission and Related Relaxation Phenomena, *Latvia*. A. Katashev, EEMT Inst., Riga Technical Univ., 1. Kalku St., Riga LV-1658, Latvia; phone/fax 371-7089383; e-mail katashev@latnet.lv.

**22–26** *Ab initio* (from Electronic Structure) Calculations of Complex Processes in Materials, *Schwaebisch Gmuend, Germany*. e-mail psik-coord@daresbury.ac.uk.

**26–30** 15th European Conf. on Atomic and Molecular Physics of Ionized Gases, *Miskolc-Lillafured, Hungary*. Z. Donko, c/o Eotvos Lorand Physical Society, H-1371 Budapest, P.O. Box 433, Hungary; e-mail escampig@elft.mtesz.hu; http://elft.mtesz.hu/escampig2000.

**26–31** Scientific Basis for Nuclear Waste Management Symposium. Sydney, Australia. Conference Secretariat, P.O. Box Q894, QVB Post Office, Sydney NSW 1230 Australia; 61 2-9262-4211; fax 6s1 2-9262-4265; e-mail facets@facetmanagement.com.au; https://www.amink.com.au/secure/ansto2000.htm. **MRS.**

**27–30** Intl. Conf. on Spectroscopy of Ultra-Thin Films and Related Systems, *Xi'an, P.R. China*. Y. Fang, Spectroscopy Lab., Experimental Ctr., Capital Normal Univ., Beijing 100037, P.R. China; e-mail yfang@bnu.edu.cn; fax 8610-6841-6837.

**28–30** ▼ 3rd Intl. Conf. on Polymer-Solvent Complexes and Intercalates, *Besancon, France*. J.M. Guenet, c/o Eotvos Lorand Physical Society, Inst. Charles Sadron, CNRS UPR 22, 6 rue Boussingault, F-67083 Strasbourg Cedex, France; 33-388-414-000; fax 33-388-414-099; e-mail guenet@ics.u-strasbg.fr; spectro.ujf-grenoble.fr/poly-solv/.

**28–30** Hysteresis, Metastability and Aftereffect HMA-2000, *Chicago, IL*. E-mail: ygogotsi@trigger.cc.uic.edu; www.uic.edu/orgs/HMA-2000/.

**28–1** Junior EUROMAT European Conf., *Lausanne, Switzerland*. B. Toelle, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7751; fax 49-69-791-7733; e-mail junior-euromat@dgm.de; www.junior-euromat.fems.org.

**30–2** ▼ Conf. on Surfaces in Biomaterials, *Scottsdale, AZ*. Surfaces in Biomaterials Foundation, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 612-512-9103; fax 612-545-0335; www.surfaces.org.

**31–5** EURESCO Conf. on Supramolecular Chemistry: Reactivity and Catalysis in Supramolecular Systems, *Urbino, Italy*. J. Henkevovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

#### SEPTEMBER 2000

**2–7** EURESCO Conf. on Inorganic Chemistry: Design and Properties of Low Nuclearity Metal Complexes, Achievements and Challenges of Organometallic Complexes in Homogeneous Catalysis, *San Felu de Guixols, Spain*. J. Henkevovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**3–7** Polycrystalline Semiconductors Conf., *St. Malo, France*. O. Bonnaud, GMV Univ. of Rennes I, 35042 Rennes Cedex, France; 33-299-286071; fax 33-299-281674; e-mail polyse2000@univ-rennes1.fr.

**3–8** ▼ 11th European Conf. on Diamond-Like Materials, Carbon Nanotubes, Nitrides, and Silicon Carbide, *Porto, Portugal*. L. Reed, Conf. Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-721; fax 44-1865-843-958; e-mail e.reed@elsevier.co.uk; www.elsevier.com/locate/diamondconf.

**3–8** Congress of Histochemistry and Cytochemistry, *York, UK*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1865-248768; fax 44-1865-791237; e-mail meetings@rms.org.uk; http://www.rms.org.uk.

**4–9** 12th Intl. Conf. on Ion Beam Modification of Materials, *Porto Alegre, Brazil*. IBMM 2000, Inst. de Física, UFRGS, Campus do Vale, Caixa Postal 15051; 91501-970 Porto Alegre/RS, Brazil; 55-51-316-6323; fax 55-51-316-6510; e-mail IBMM2000@if.ufrgs.br.

**4–10** 6th Seminar on Computational Physics, *Granada, Spain*. J. Marro, Inst. "Carlos I" for Theoretical and Computational Physics, Facultad de Ciencias, Univ. of Granada, 18071-Granada, Spain; fax 34-958-242-862; e-mail cphys@ugr.es; http://ergodic.ugr.es/cpl/.

**5–8** ▼ 19th European Conf. on Surface Science, *Madrid, Spain*. E.G. Michel, Dto. de Física de Materia Condensada, Univ. Autónoma de Madrid, 28049 Madrid, Spain; 34-91-397-4759; fax 34-91-397-3961; e-mail ecos19@uam.es; ecos.fmc.uam.es/cpl/.

**5-19** 2nd Intl. Smakula Symposium: Basic and Applied Problems of Modern Physics, *Ternopol, Ukraine*. V. Shenderovsky; Deputy Chairman of the Organizing Committee, Inst. of Physics of the Natl. Academy of Sciences of Ukraine, Kyiv 030039, Ukraine; fax 380-44-265-5671.

**6-9** ACerS Pacific Coast Regional Meeting with Basic Science Div., *San Francisco, CA*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

**9-14** EuroConference on Atoms and Molecules in Super-Intense Laser Fields, *Acquafredda di Maratea, Italy*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**9-15** Intl. Symposium on the Process Metallurgy of Uranium, *Saskatoon, Canada*. C. Edwards, 306-956-6323; fax 306-956-6533; e-mail chuck\_edwards@cameco.com.

**9-15** Particle Physics and Gravitation: EuroConference on Quantum Fields and Strings, *Crete, Greece*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**10-13** ▼ 37th IMAPS Nordic Conf., *Helsingør, Denmark*. IMAPS Nordic, P.O. Box 277, SE-431 24 Mölndal, Sweden; fax 46-19-56-7070; e-mail info@imapsnordic.a.se; www.imapsnordic.a.se.

**10-14** ACerS Functionally Graded Materials Conf., *Estes Park, CO*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**10-15** Conf. on Lasers and Electro-Optics/Europe, and Intl. Quantum Electronics Conf., *Nice, France*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**13-15** 7th Intl. Conf. on Computer Methods in Composite Materials and Structures, *Bologna, Italy*. Conf. Secretariat CADCOMP 2000, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail wit@wessex.ac.uk; http://www.wessex.ac.uk/conferences/2000.

**13-15** ▼ Conf. on Photomask Technology and Management, *Monterey, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**13-15** European Metallographic Conf., *Saarbrücken, Germany*. P.P. Schopp, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7750; fax 49-69-791-7733; e-mail vdb@dgm.de; www.euromet.dgm.de.

**13-15** Intl. Congress on Extractive Metallurgy and Mineral Processing, *Melbourne, Australia*. M.F. Marcini, Lev. 13, 15-31 Pelham St., Carlton, Victoria, Australia 3053; 61-3-4662-3166; fax 61-3-4662-3662.

**13-16** 2nd Intl. Conf. on Inorganic Materials, *Santa Barbara, CA*. S. Wilkinson, 2nd Intl. Conf. on Inorganic Materials, Elsevier Science Ltd., The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843691; fax 44-1865-843958; e-mail sm.wilkinson@elsevier.co.uk; www.elsevier.com/locate/im2000.

**16-21** EURESCO Conf. on Plasticity of Materials, *Acquafredda di Maratea, Italy*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**17-21** 9th Intl. Symposium on Superalloys, *Champion, PA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org.

**17-22** 13th Intl. Conf. on Ion Implantation Technology, *Tyrol, Austria*. IIT 2000, c/o IIS-B, Schottkystrasse 10, 91058 Erlangen, Germany; 49-9131-761-100; fax 49-9131-761-102; e-mail iit2000@iis-b.fhg.de; http://www.mfa.kfi.hu/IIT2000.

**17-22** 25th Intl. Conf. on the Physics of Semiconductors, *Osaka City, Japan*. C. Hamaguchi; 81-6-6879-7765; fax 81-6-6879-7753; e-mail hamaguti@ele.eng.osaka-u.ac.jp; http://mc-net.jtbcom.co.jp/icps25.

**17-22** 28th Photovoltaic Specialists Conf., *Anchorage, AK*. A. Rohatgi, Georgia Inst. of Technology, School of Electrical and Computer Engineering, 777 Atlantic Dr., Atlanta, GA 30332-0250; 404-894-7692; 404-894-5934; e-mail ajeet.rohatgi@ece.gatech.edu; http://ieeepvs@nrel.gov.

**17-22** Applied Superconductivity Conf., *Virginia Beach, VA*. Courtesy Associates, 2000 L St. NW, Ste. 710, Washington, DC 20036; 202-973-8692; fax 202-331-0111; e-mail asc@courtesyassoc.com.

**18-19** ▼ SPIE Regional Meeting on Optoelectronics, Photonics, and Imaging, *Charlotte, NC*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**18-20** 4th Conf. on Aerospace Materials, Processes, and Environmental Technology, *Huntsville, AL*. J. Weiner, 4th Conf. on Aerospace Materials, Processes, and Environmental Technology, P.O. Box 928, Huntsville, AL 35804; 256-533-5923; e-mail jweiner@aol.com; http://ampet.msfc.nasa.gov.

**18-22** Intl. Conf. on Materials and Coatings for Extreme Environments Performance, *Crimea, Ukraine*. Organizing Committee "MEE 2000," Inst. for Problems of Materials Science, 3 Krzhynzhovskiy Str., 03142 Kiev, Ukraine; 380-44-444-3231; fax 380-44-444-2131; e-mail chern@materials.kiev.ua.

**19** ▼ Single Chip Packaging Conf., *Boston, MA*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**20-22** ▼ 33rd IMAPS Intl. Symposium on Microelectronics, *Boston, MA*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**21-22** Intl. Activated Carbon Conf., *Pittsburgh, PA*. B. Sherman, Professional Analytical and Consulting Services, 409 Meade Dr., Coraopolis, PA 15108; 724-457-6576; fax 724-457-1214; e-mail hnpacs@aol.com; members.aol.com/hnpacs/pacs.htm.

**22-24** ▼ IMAPS Advanced Technology Workshop on Chip Scale Packaging, *North Falmouth, MA*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**24-27** ACerS Manufacturing Workshop, *Louisville, KY*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**24-28** Bulk Metallic Glasses, Singapore, United Engineering Foundation Conferences, Three Park Avenue, 27th Floor, *New York, NY* 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org/engfnd/Oat.html.

**25-27** ▼ Conf. on Permanent Magnet Systems, *Atlanta, GA*. C. Jones, Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

**25-27** Intl. Conf. on Tungsten and Refractory Metals, *Annapolis, MD*. Metal Powder Industries Federation; 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpi.org.

**25-28** ▼ Conf. on Interferometry in Speckle Light, *Lausanne, Switzerland*. Interferometry in Speckle Light, IMAC-EPFL GC-Ecublens, CH-1015 Lausanne, Switzerland; 41-21-693-2444; fax 41-21-693-4748; e-mail IntSL2000.board@epfl.ch.

**25-28** Intl. Congress on Advanced Materials, Their Processes, and Applications, *Munich, Germany*. Werkstoffwoche-Partnerschaft GBRmbH, Hamburger Allee 26, 60486 Frankfurt, Germany; 49-69-791-7747; fax 49-69-791-7733; e-mail materialsweek@dgm.de; www.materialsweek.org.

**27-28** Intl. Conf. on Magnesium Alloys and Their Applications, *Munich, Germany*. Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7758; fax 49-69-791-7733; e-mail magnesium@dgm.de; www.magnesium.dgm.de.

**27-30** Worlds in Transition: Technoscience, Citizenship, and Culture in the 21st Century: Conf. of the Society for Social Studies of Science and the European Assoc. for the Study of Science and Technology, *Vienna, Austria*. U. Felt, Prof. of Social Studies of Science, Dept. of Philosophy of Science and Social Studies of Science, Univ. of Vienna, Sensengasse 8/10, A-1090 Vienna, Austria; 43-1-4277-47611; fax 43-1-4277-9476; e-mail 4SEASST@univie.ac.at; www.univie.ac.at/wissenschaftstheorie/.

**29-30** Fall Meeting of APS Four Corners Section, *Ft. Collins, CO*. H.D. Hochheimer, Dept. of Physics, Colorado State Univ., Ft. Collins, CO 80523; 970-491-6246; fax 970-491-7947; e-mail aps4cs@lamar.colostate.edu; http://lamar.colostate.edu/\_aps4cs/.

**30-5** EURESCO Conf. on Surface Engineering for Protection of Metals and Alloys, *Acquafredda di Maratea, Italy*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

## OCTOBER 2000

**1-4** Brimacombe Memorial Symposium, *Vancouver, Canada*. I. Samarasekera, Advanced Materials and Processing Engineering Lab., Univ. of British Columbia, Rm. 111-2355 East Mall, Vancouver, BC, Canada V6T 1Z4; 604-822-3668; fax 604-822-2965; e-mail indir@cmpe.ubc.ca.

**1-4** ACerS Glass and Optical Materials Division Fall Meeting, *Corning, NY*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**2-6** AVS 47th Intl. Symposium, *Boston, MA*. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005-3993; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; http://www.vacuum.org.

**3-5** Advanced Metallization Conference (AMC) 2000, *San Diego, California*. 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu.

**4-7** Meeting of the APS Division of Nuclear Physics, *Williamsburg, VA*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**7–12** EURESCO Conf. on Fundamental Aspects of Epitaxial Growth, *Castelvecchio Pascoli, Italy*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**8–11** ACerS Electronics Division Fall Meeting, *Tmscon, SC*. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**8–12** TMS Fall Meeting, *St. Louis, MO*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org.

**11–13** 14th Intl. Conf. on Optical Fiber Sensors, *Venice, Italy*. A. Grazia Mignani, IROE-CNR, Optics and Photonics Dept., Via Panciatichi 64, I-50127 Firenze, Italy; 39-55-4235-262; fax 39-55-4379-569; e-mail mignani@iroe.fi.cnr.it.

**11–15** Intl. Symposium on Small Particles and Inorganic Clusters, *Atlanta, GA*. K. Mims, Georgia Inst. of Technology, P.O. Box 93686, Atlanta, GA 30377-0686; 404-385-0383; e-mail CNNGT@mse.gatech.edu; www.conted.gatech.edu/programs/.

**13–14** APS Ohio Section Fall Meeting, *Toldeo, OH*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

**14–16** 13th Intl. Symposium on Superconductivity, *Tokyo, Japan*. M. Yoshida, ISS 2000 Secretariat, ISTE, Shinbashi 5-34-3, Minato-ku, Tokyo 105-0004, Japan; fax 81-3-3431-4044; e-mail josch da@istec.or.jp; www.istec.or.jp.

**14–19** EuroConference on Quantum Optics, *Mallorca, Spain*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**16–17** 3rd Intl. Conf. on Materials for Microelectronics, *Dublin, Ireland*. C. Pearcey, Conf. & Events, (CO19) IOM Communications Ltd., 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-207-451-7340; fax 44-207-839-2289; e-mail Cathy\_Pearcey@materials.co.uk; www.materials.org.uk.

**16–18** Annual Symposium on Optical Materials for High Power Lasers, *Boulder, CO*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**16–18** Georgia Tech Conf. on Nanoscience and Nanotechnology, *Atlanta, GA*. Georgia Inst. of Technology, P.O. Box 93686, Atlanta, GA 30377-0686; 404-385-3501; fax 404-894-8925; e-mail conted@gatech.edu; www.conted.gatech.edu/programs/.

**16–21** 14th Intl. Spin Physics Symposium, *Osaka, Japan*. T. Nakano, RCNP, Osaka Univ., Mihogaoka 10-1, Ibaraki, Osaka 567-0047, Japan; 81-6-6879-8938; fax 81-6-6879-8899; e-mail spin2000@rcnp.osaka-u.ac.jp; www.rcnp.osaka-u.ac.jp/\_spin2000.

**18–20** European Powder Metallurgy Assoc. Conf., *Munich, Germany*. European Powder Metallurgy Assoc., Old Bank Bldgs., Bellstone, Shrewsbury SY1 1HU, UK; 44-1743-248899; fax 44-1743-362968; e-mail info@epma.com; www.epma.com.

**19–21** 16th Meeting of the Academy of Surgical Research, *Cincinnati, OH*. Academy of Surgical Research, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 612-545-1919; fax 612-545-0335; www.surgicalresearch.org.

**19–24** EURESCO Conf. on High Performance Fibers, *Palma de Mallorca, Spain*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**20–21** 2nd Intl. Symposium on Designing, Processing, and Properties of Advanced Engineering Materials, *Guilin, P.R. China*. R. Yang, ISAEM Secretariat, Inst. of Metal Research, 72 Wenhua Rd., Shenyang 110015, P.R. China; 86-24-2384-3531-55781; fax 86-24-2389-1320; e-mail ryang@pub.sy.cn; www.imr.ac.cn/ISAEM-2000.html.

**20–28** OSA Annual Meeting, *Providence, RI*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**22–25** TMS Fall Extraction and Process Metallurgy Meeting, *Pittsburgh, PA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org/cms.

**22–26** Optical Networking and Communications Conf., *Richardson, TX*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**22–27** 198th Meeting of The Electrochemical Society, *Phoenix, AZ*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; http://www.electrochem.org/meetings/.

**23–27** Meeting of the APS Division of Plasma Physics, *Quebec, Canada*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**24–27** 53rd Annual Gaseous Electronics Conf., *Houston, TX*. D. Economou, Univ. of Houston, Dept. of Chemical Engineering, 4800 Calhoun Rd., Houston, TX 77204-4792; 713-743-4320; fax 713-743-4323; e-mail economou@uh.edu; www.chee.uh.edu.

**25–28** ACS Midwest Regional Meeting, *St. Louis, MO*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**25–28** ACS Western Regional Meeting, *San Francisco, CA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**27–28** SRC Annual Users Meeting and Workshop on Atomic and Molecular Physics, *Stoughton, WI*. R. Wehlitz, Synchrotron Radiation Ctr., 3731 Schneider Dr., Stoughton, WI 53589; 608-877-2134; fax 608-877-2001; e-mail wehlitz@src.wisc.edu.

**28–29** Joint Fall Meeting of the Texas Sections of APS, AAPT, and Zone 13 of the SPS, *Houston, TX*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

**29–31** 3rd BCC Conf. on Fine, Ultrafine, and Nano Powders, *Montreal, Quebec, Canada*. S. Faust, Conf. Coordinator, Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 203-853-0348; e-mail buscomm1@aol.com; www.buscom.com.

**29–2** 3rd Intl. Conf. on Coatings on Glass, *Maastricht, The Netherlands*. 3rd-ICCG, Kongresservice Brabant, P.O. Box 141, 5500 AC Veldhoven, The Netherlands; 31-40-254-7171; fax 31-40-254-6566; e-mail 3rd-iccg@tpd.tno.nl; www.tpd.tno.nl/3rd-iccg.

**29–2** 15th Annual Natl. Educators' Workshop, *Kettering, OH*. Natl. Educators' Workshop: Update 2000, School of Science and Technology, Norfolk State Univ., 700 Park Ave., Norfolk, VA 23504-8060; 757-823-8109; fax 757-823-8215; e-mail dplaclair@nsu.edu.

**29–3** MCS/ACerS Manufacturing Workshop, *Monterrey, Mexico*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

**30–2** 4th Intl. Conf. on High-Strength Low-Alloy Steels, *Xi'an, China*. HSLA Steels 2000 Secretariat, CSM, 46 Dongsixi Dajie, Beijing, China 100711; 86-10-6513-3925; fax 86-10-6512-4122; e-mail csm@public.bta.net.cn.

**30–2** 2000 U.S. Workshop on the Physics and Chemistry of II-VI Materials, *Albuquerque, NM*. Laura Manganiello, Palisades Institute for Research Services, Inc., 411 Lafayette Street, 2nd Floor, New York, NY 10003; 212-460-8090; x206; fax 212-460-5460; www.ii-viworkshop.org.

## NOVEMBER 2000

**1–4** 16th Intl. Conf. on the Application of Accelerators in Research and Industry, *Denton, TX*. J. Duggan; 940-565-3252; e-mail stippec@unt.edu; www.phys.unt.edu/accelconf/.

**2–4** Meeting of the APS Southeastern Section, *Starkville, MS*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**3–8** Photonics East Conf., *Boston, MA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**5–8** 2nd Intl. Conf. on Processing Materials for Properties, *San Francisco, CA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org/cms.

**5–8** 6th Biennial Conf. on Organic Coatings, *Hilton Head Island, SC*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail narc@ims-np.org; www.ims-np.org/.

**6–8** 14th Intl. Conf. and Workshops on Applied Geologic Remote Sensing, *Las Vegas, NV*. Veridian-ERIM Intl., P.O. Box 134008, Ann Arbor, MI 48113-4008; 734-994-1200; fax 734-994-5123; www.irim-int.com/conf/conf.html.

**8–9** Intl. Conf. on Material Science and Technologies, *Jerusalem, Israel*. AGIL Conf. Secretariat, Assoc. of Engineers and Architects in Israel, 200 Dizengoff St., P.O. Box 3082, Tel-Aviv 61030, Israel; www.intersoft.co.il/agil.htm.

**8–10** 3rd Biennial Conf. on Polymer Stabilizers and Modifiers, *Hilton Head Island, SC*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail narc@ims-np.org; www.ims-np.org/.

**11–15** Intl. Conf. on Elementary Processes in Molecule-Letal Surface Interactions, *San Juan, Puerto Rico*. E. Rivera, Conf. Coordinator, Resource Ctr. for Science and Engineering, P.O. Box 23334, San Juan, PR 00931-3334; 787-764-8369; 787-756-7717; e-mail evelyn@adam.uprr.pr; web.uprr.pr/icepl/.

**12–17** AIChE Annual Meeting, *Los Angeles, CA*. AIChE, 3 Park Ave., New York, NY 10016; http://www.aiche.org.

**13–14** ASTM Symposium on Marine Corrosion in Tropical Environments, *Merida, Yucatan, Mexico*. V. Chaker, Port Authority of NY-NJ, One World Trade Ctr., 74W, New York, NY 10048; 212-435-5790; fax 215-435-8040.

**13–15** Intl. Conf. on Continuous Casting, *Frankfurt, Germany*. A. Tinnemans, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7758; 49-69-791-7733; e-mail at@dgm.de; www.dgm.de.

**15–16** ASTM Symposium on Mechanical Properties of Structural Films, *Orlando, FL*. ASTM Symposia Operations, 100 Barr Harbor Dr., West Conshohocken, PA 19428-2959; 610-832-9677; www.astm.org.

19-21 Meeting of the APS Division of Fluid Dynamics, *Washington, DC*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

19-22 ▼ 3rd Intl. Conf. on High-Temperature Capillarity, *Kurashiki, Japan*. K. Nogi, Joining and Welding Research Inst., Osaka Univ., 11-1 Mihogaoka, Ibaraki, Osaka, Japan; phone and fax 81-6-6879-8643; e-mail nogisan@jwri.osaka-u.ac.jp.

19-23 1st Intl. Conf. on Advanced Materials Processing, *Rotorua, New Zealand*. D. Zhang, Dept. of Mat. and Proc. Engineering, Univ. of Waikato, Private Bag 3105, Hamilton, New Zealand, fax 64-7-838-4835; e-mail d.zhang@waikato.ac.nz.

20-22 Intl. Symposium on Fuel Cells for Vehicles, *Nagoya, Japan*. Y. Takeda, Dept. of Chemistry, Faculty of Engineering, Mie Univ., Kamihama, Tsu 514-8507, Japan; 81-59-231-9419; fax 81-59-231-9478; e-mail takeda@chem.mie-u.ac.jp; http://elech.kuic.kyoto-u.ac.jp:8080/-dengji/.

21-24 7th NCB Intl. Seminar on Cement and Building Materials, *New Delhi, India*. Organizing Secretary, 7th NCB Intl. Seminar, Natl. Council for Cement and Building Materials, P-21 South Extension 11, Post Box No. 3885, New Delhi 110049, India; 91-129-242051-56; fax 91-129-242100; e-mail nccbm@giasdl01.vsnl.net.in.

27-1 ▼ 4th Intl. Conf. on Monte Carlo and Quasi-Monte Carlo Methods in Scientific Computing, *Hong Kong*. Statistics Research and Consultancy Unit, Hong Kong Baptist Univ., Kowloon Tong, Hong Kong; e-mail mcqmc2000@www.mcqmc.org; www.mcqmc.org/MCQMC2000.html.

27-1 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; http://www.mrs.org/. MRS.

## DECEMBER 2000

3-5 ▼ 18th Annual Membrane Technology/Separations Planning Conf., *Newton, MA*. Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 203-853-0348; e-mail buscomm1@aol.com; www.buscom.com.

3-6 ▼ 3rd Workshop on Polymeric Materials for Microelectronics and Photonics Applications, *London, UK*. E. Suhir, Lucent Technologies, 600 Mountain Ave., Rm. 1D-443, Murray Hill, NJ 07974; 908-582-5301; fax 908-582-5106; e-mail suhir@lucent.com. **Endorsed.**

4-8 Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Las Vegas, NV*. T. Chandra, Univ. of Wollongong, Dept. of Materials Engineering, Northfields Ave., Wollongong NSW 2522, Australia; 61-42-21-3008; fax 61-42-21-3112; e-mail t.chandra@uow.edu.au.

6-8 ▼ ACS Southeast/Southwest Regional Meeting, *New Orleans, LA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

## JANUARY 2001

6-11 AAPT and AAS Joint Winter Meeting, *San Diego, CA*. AAPT Meetings Dept., One Physics Ellipse, College Park, MD 20740; e-mail aapt-meet@aapt.org; www.aapt.org.

7-10 Workshop on Nanostructured Materials Made from Self-Assembled Molecules and Particles, *Hindas, Sweden*. A. Palmqvist, Chalmers University of Technology, SE-412 96 Goeteborg, Sweden; fax 46-31-7722967; e-mail anders.palmqvist@surfchem.chalmers.se; www.kck.chalmers.se.

8-10 ▼ PLASTEC™ West Plastics Conf., co-located with Medical Design & Manufacturing and Pacific Design & Manufacturing Conf., *Anaheim, CA*. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

20-26 ▼ Photonics West Conf., *San Jose, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

21-26 ▼ 25th Intl. Conf. on Advanced Ceramics and Composites, *Cocoa Beach, FL*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

28-31 ▼ Microtech Conf., *West London, UK*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

## FEBRUARY 2001

5-7 IEEE Intl. Solid-State Circuits Conf., *San Francisco, CA*. D. Suiters, 202-331-2000; e-mail isscc@courtesyassoc.com.

5-9 Advanced Research Workshop on Semiconductor Nanostructures, *Blenheim, New Zealand*. D.J. Lockwood, Inst. for Microstructural Sciences, Natl. Research Council of Canada, 1191 Montreal Rd., Bldg. M-36, Ottawa, Ontario, Canada K1A 0R6; 613-993-9614; fax 613-993-6486; e-mail david.lockwood@nrc.ca.

11-15 TMS Annual Meeting, *New Orleans, LA*. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; http://www.tms.org/cms.

19-22 ▼ 4th Industrial Energy Efficiency Symposium, *Washington, DC*. Office of Industrial Technologies, EE-20, U.S. Dept. of Energy, 1000 Independence Ave., S.W., Washington, DC 20585; www.oitexpo4.com.

## MARCH 2001

5-8 ▼ Intl. Laser Safety Conf., *San Diego, CA*. Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail lia@laserinstitute.org; www.laserinstitute.org.

11-15 10th Biennial Workshop on Organometallic Vapor Phase Epitaxy, *San Diego, CA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

12-16 APS March Meeting, *Seattle, WA*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

25-30 199th Meeting of the Electrochemical Society, *Washington, DC*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; http://www.electrochem.org/meetings/. **Symposium Endorsed.**

## APRIL 2001

16-20 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; http://www.mrs.org. MRS.

20-26 ▼ 44th SVC Conf., *Philadelphia, PA*. Society of Vacuum Coaters, 71 Pinon Hill Place, N.E., Albuquerque, NM 87122-1914; 505-856-7188; 505-856-6716; e-mail svcinfo@svc.org.

22-25 ▼ Conf. on Materials and Science in Sports, *Coronado, CA*. F.H. Froes, Univ. of Idaho, Inst. of Materials and Advanced Proc., Mines Bldg., Rm. 321, Moscow, ID 83844-3026; 208-885-7989; fax 208-885-4009; e-mail imap@uidaho.edu.

22-26 ▼ 13th Intl. Conf. on Wear of Materials, *Vancouver, British Columbia, Canada*. A. Hill, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1993-843-643; fax 44-1993-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com.

22-26 ▼ AIChE Spring National Meeting, *Houston, TX*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

23-27 APS April Meeting, *Washington, DC*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

## MAY 2001

6-11 Conf. on Lasers and Electro-Optics, and Quantum Electronics and Laser Science Conf., *Baltimore, MD*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org/mtg\_conf.

16-25 Sikkim Intl. Nanotribology Symposium, *Sikkim, India*. S.K. Biswas, Dept. Mechanical Engineering, Indian Institute of Science, Bangalore 560012, India; 91-80-3600586/3092963; fax 91-80-3600648; nanosikkim@mecheng.iisc.ernet.in; www.mecheng.iisc.ernet.in/nanosikkim.html.

23-25 4th Intl. Conf. on Marine Technology, *Szczecin, Poland*. K. Savage, Wessex Inst. of Technology, WIT Marketing Coordinator, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail ksavage@wessex.ac.uk.

## JUNE 2001

5-7 ▼ PLASTEC™ East Plastics Conf., co-located with Medical Design & Manufacturing East and Atlantic Design & Manufacturing Conf., *New York, NY*. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

10-13 75th Colloid and Surface Science Symposium, *Pittsburgh, PA*. S. Garoff, 412-268-6877; fax 412-681-0648; e-mail sg2e@andrew.cmu.edu.

10-14 ▼ EUROMAT 2001 Conf., *Rome, Italy*. AIM, Piazzale Rodolfo Morandi 2-1-20121 Milano, Italy; 39-2-7639-7770; fax 39-2-7602-0551; e-mail aim@fast.mi.it; www.fast.mi.it/aim/euromat.htm.

17-20 5th Intl. Special Emphasis Symposium on Superalloys 718, 625, 706, and Derivatives, *Pittsburgh, PA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

23-30 12th APS Topical Conf. on Shock Compression of Condensed Matter, *Atlanta, GA*. A. Roach, Los Alamos Natl. Lab.; 505-665-6277; e-mail alita@lanl.gov.

27-29 ▼ Electronic Materials Conf., *Notre Dame, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

## JULY 2001

16-20 4th Intl. Conf. on Nitride Semiconductors (ICNS-4), *Denver, CO*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org. MRS.

16-20 Cryogenic Engineering Conference & International Cryogenic Materials Conference (CEC-ICMC), *Madison, WI*. Centennial Conferences, 4800 Baseline Road, A-112, Boulder, CO 80303 USA; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.cec-icmc.org

23-27 ▼ 13th Intl. Conf. on Vacuum UV Radiation Physics, *Trieste, Italy*. e-mail renato.gioppo@elettra.trieste.it; vuv13.elettra.trieste.it/vuv13/.

29-3 19th Intl. Conf. on Atomic Collisions in Solids, *Paris, France*. V.A. Esaulov, Lab. des Collisions Atomiques et Moléculaires, Bat. 351, Univ. de Paris Sud, 91405 Orsay Cedex, France; 33-69-15-76-80; fax 33-69-15-76-71; e-mail icacs19@veof1.lcam.u-psud.fr; http://veof1.lcam.u-psud.fr/idc/icacs19.html.

29-3 SPIE Annual Meeting and Intl. Symposium on Optical Science and Technology, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

30-3 4th Intl Conf. on Biological Physics, *Kyoto, Japan*. M. Go, Div. of Biological Science, Graduate School of Science, Nagoya Univ., Furo-cho, Chikusa-ku, Nagoya 464-8602, Japan; e-mail icbp2001@kokusai.phys.nagoya-u.ac.jp; kokusai.phys.nagoya-u.ac.jp/.

AUGUST 2001

12-17 10th Intl. Conf. on Phonon Scattering in Condensed Matter, *Hanover, NH*. Phonons 2001, Dept. of Physics and Astronomy, Dartmouth College, HB 6127, Hanover, NH 03755; e-mail phonons@mac.dartmouth.edu; www.dartmouth.edu/~phonon.

26-31 13th European Conference on Chemical Vapor Deposition (EUROCV13), *Athens, Greece*. Web site www.imel.demokritos.gr/EUROCV D/Eurocvd13.html.

27-31 Conf. on Recrystallization and Grain Growth, *Aachen, Germany*. D.A. Molodov, Inst. für Metallkunde und Metallphysik, RWTH Aachen, D-52056 Aachen, Germany; fax 49-241-888-8608; e-mail ReX&GG@imm.rth-aachen.de.

SEPTEMBER 2001

2-7 200th Meeting of the Electrochemical Society and 52nd Meeting of the Intl. Society of Electrochemistry, *San Francisco, CA*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

16-21 Intl. Conf. on Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions, *Moran, WY*. N.R. Moody, SNL, P.O. Box 969, MS-9404, Livermore, CA 94551; 925-294-2622; fax 925-294-3410. Endorsed.

18-21 Intl. Conf. on Advances in Materials and Processing Technologies, *Madrid, Spain*. AMPT'01 Congress Secretariat, Fundación Univ. Carlos III, CON-GREGA, Avda. de la Universidad 30, 28911 Leganés, Spain; 34-91-624-9142; fax 34-91-624-9147; e-mail congrega@fund.uc3m.es; e-mail ampt01@ing.uc3m.es.

23-26 TMS Fall Extraction and Process Metallurgy Meeting, *San Diego, CA*. M. Cross, School of Computing and Mathematical Science, Univ. of Greenwich, Woolwich Campus, Wellington St., Woolwich, London SE18 6PF, UK; 44-208-331-8702; fax 44-208-331-8695.

23-27 3rd Intl. Symposium on Structural Intermetallics, *Jackson Hole, WY*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

23-27 6th World Congress of Chemical Engineering, *Melbourne, Australia*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

23-27 ACS Southeast Regional Meeting, *Savannah, GA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

OCTOBER 2001

3-5 Conf. on Photomask Technology and Management, *Monterey, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

10-13 ACS Midwest Regional Meeting, *Lincoln, NE*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

17-20 ACS Southwest Regional Meeting, *San Antonio, TX*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

28-31 ACS Western Regional Meeting, *Santa Barbara, CA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

29-2 Meeting of the APS Div. of Plasma Physics, *Long Beach, CA*. APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

NOVEMBER 2001

4-8 Intl. Conf. on Advanced Ceramics and Glasses, *Maui, HI*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

4-8 TMS Fall Meeting, *Indianapolis, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail weissp@tms.org; www.tms.org.

4-9 AIChE Annual Meeting, *Reno, NV*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

26-30 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; www.mrs.org. MRS.

DECEMBER 2001

3-7 10th Intl. Congress of Fracture, *Honolulu, HI*. A. Hill, ICF10 Congress Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com.

11-15 4th Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI*. S. Hanada, Tohoku Univ., Inst. for Materials Research, Katahira 2-1-1, Aoba-ku, Sendai 980-8577, Japan; 81-22-215-2115; fax 81-22-215-2116; e-mail ccpricm4@imr.tohoku.ac.jp. □

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